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捷多邦,专业PCB打样工厂,24小时加急

2SA2009

Silicon PNP epitaxial planer type

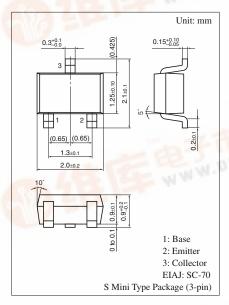
For low-frequency high breakdown voltage amplification

Features

- High collector to emitter voltage V_{CEO}
- Low noise voltage NV

Absolute maximum ratings $T_a = 25$ C							
Parameter	Symbol	Rating	Unit				
Collector to base voltage	V _{CBO}	-120	V				
Collector to emitter voltage	V _{CEO}	-120	V				
Emitter to base voltage	V _{EBO}	-5	V				
Peak collector current	I _{CP}	-50	mA				
Collector current	I _C	-20	mA				
Collector power dissipation	P _C	150	mW				
Junction temperature	Tj	150	°C				
Storage temperature	T _{stg}	-55 to +150	°C				

Absolute Maximum Ratings $T_a = 25^{\circ}C$



Marking Symbol: AR

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff current	I _{CBO}	$V_{CB} = -50 \text{ V}, I_E = 0$			-100	nA
199 2 Pt 1-1	I _{CEO}	$V_{CE} = -50 \text{ V}, I_B = 0$			-1	μΑ
Collector to base voltage	V _{CBO}	$I_{C} = -10 \ \mu A, \ I_{E} = 0$	-120			V
Collector to emitter voltage	V _{CEO}	$I_{\rm C} = -1 {\rm mA}, I_{\rm B} = 0$	-120		100	V
Emitter to base voltage	V _{EBO}	$I_E = -10 \ \mu A, \ I_C = 0$	-5	_	218	V
Forward current transfer ratio *	h _{FE}	$V_{CE} = -5 \text{ V}, I_C = -2 \text{ mA}$	180	150	700	WW.
Collector to emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = -20 \text{ mA}, I_{\rm B} = -2 \text{ mA}$	1.12		- 0.6	V
Noise voltage	NV	$V_{CE} = -40 \text{ V}, I_C = -1 \text{ mA}, G_V = 80 \text{ dB}$ $R_g = 100 \text{ kW}, \text{ Function} = \text{FLAT}$		130		mV
Transition frequency	f _T	$V_{CB} = -5 \text{ V}, I_E = 2 \text{ mA}, f = 200 \text{ MHz}$		120		MHz

Note) *: Rank classification

Rank	R	S	Т
h _{FE}	180 to 360	260 to 520	360 to 700



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